TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

M T 6 L 5 2 A E

VHF~UHF BAND LOW NOISE AMPLIFIER APPLICATIONS

Unit in mm

MT6L52AE

TWO devices are built in to the super-thin and extreme super mini (6 pins) package: ES6

MOUNTED DEVICES

	Q1 : SSM (TESM)	Q2:SSM (TESM)
Three-pins (SSM/TESM) mold	MT3S03S	MT3S04AS
products are corresponded.	(MT3S03T)	(MT3S04AT)

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	Q1	Q2	UNIT
Collector-Base Voltage	v_{CBO}	10	10	V
Collector-Emitter Voltage	V_{CEO}	5	5	V
Emitter-Base Voltage	V_{EBO}	2	2	V
Collector Current	$I_{\mathbb{C}}$	40	40	mA
Base Current	$I_{\mathbf{B}}$	10	10	mA
Collector Power Dissipation	PC (Note 1)	100		mW
Junction Temperature	T_{j}	12	°C	
Storage Temperature Range	$\mathrm{T_{stg}}$	-55~125		°C

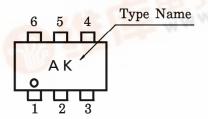
1.2±0.05 16+005 1. COLLECTOR 1 4. BASE 2 2. EMITTER 1 EMITTER 2 5. COLLECTOR 2 BASE 1 **JEDEC EIAJ TOSHIBA** 2-2N1C

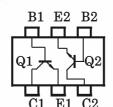
(Note 1): Total power dissipation of Q1 and Q2.

MARKING

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PIN ASSIGNMENT (TOP VIEW)





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ELECTRICAL CHARACTERISTICS Q1 (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	I_{CBO}	$V_{CB} = 5 V, I_{E} = 0$	_	_	0.1	μ A
Emitter Cut-off Current	${ m I}_{ m EBO}$	$V_{EB} = 1 V, I_{C} = 0$	_	_	1	μ A
DC Current Gain	${ m h_{FE}}$	$V_{CE} = 1 V$, $I_{C} = 5 mA$	80	_	160	_
Transition Frequency	f _T (1)	$V_{CE} = 1 V$, $I_{C} = 5 mA$	3	5	_	GHz
	f _T (2)	$ m V_{CE} = 3~V,~I_{C} = 10~mA$	7	10	_	GHz
Incortion (-ain —	$ S_{21e} ^2$ (1)	$ m V_{CE}=1~V,~I_{C}=5~mA,~f=2~GHz$	_	5	_	dB
	$ S_{21e} ^2$ (2)	$V_{CE} = 3 \text{ V}, I_{C} = 20 \text{ mA}, f = 2 \text{ GHz}$	3	6.5	_	dB
I Noise Rigure	NF (1)	$ m V_{CE}=1~V,~I_{C}=5~mA,~f=2~GHz$	_	1.7	3	dB
	NF (2)	$ m V_{CE}=3~V,~I_{C}=7~mA,~f=2~GHz$	_	1.4	2.2	dB
Reverse Transfer Capacitance	$\mathrm{C_{re}}$	$V_{CB} = 1 V, I_{E} = 0,$ f = 1 MHz (Note 2)	_	0.8	1.15	pF

ELECTRICAL CHARACTERISTICS Q2 (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	I_{CBO}	$V_{CB} = 5 V, I_E = 0$	_	_	0.1	μ A
Emitter Cut-off Current	$I_{ m EBO}$	$V_{EB} = 1 V, I_{C} = 0$	_	_	1	μ A
DC Current Gain	$_{ m h_{FE}}$	$V_{CE} = 1 V$, $I_{C} = 5 mA$	80	_	160	_
I'I'ransition E'requency —	f _T (1)	$V_{CE} = 1 V$, $I_{C} = 5 mA$	2	4.5	_	GHz
	f _T (2)	$ m V_{CE} = 3 V, I_{C} = 7 mA$	5	7	_	GHz
Incortion (-ain	$ S_{21e} ^2$ (1)	$ m V_{CE}=1~V,~I_{C}=5~mA,~f=1~GHz$	_	8.5	_	dB
	$ S_{21e} ^2$ (2)	$V_{CE} = 3 \text{ V}, I_{C} = 20 \text{ mA}, f = 1 \text{ GHz}$	7.5	11	_	dB
Noise Figure NF (1) NF (2)	NF (1)	$V_{\mathrm{CE}} = 1 \mathrm{V}, \mathrm{I}_{\mathrm{C}} = 5 \mathrm{mA}, \mathrm{f} = 1 \mathrm{GHz}$	_	1.3	2.2	dB
	NF (2)	$V_{\mathrm{CE}} = 3 \mathrm{V}, \mathrm{I}_{\mathrm{C}} = 7 \mathrm{mA}, \mathrm{f} = 1 \mathrm{GHz}$	_	1.2	2	dB
Reverse Transfer Capacitance	C_{re}	$V_{CB} = 1 V, I_{E} = 0,$ f = 1 MHz (Note 2)	_	0.9	1.25	pF

(Note 2): C_{re} is measured by 3 terminal method with capacitance bridge.

HANDLING PRECAUTION

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.